

Appl. No. 10/695,187  
Amtd. Dated March 20, 2006  
Reply to Office Action of January 18, 2006

Docket No. IS01207AP  
Customer No. 22917


## UNITED STATES PATENT AND TRADEMARK OFFICE

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APPLICANT(S) Weigler, et al. GROUP ART UNIT: 1725  
APPLN. NO.: 10/695,187 EXAMINER: Jonathan J. Johnson  
FILED: 10/28/2003 Confirmation No. 4286  
TITLE: VERTICAL REMOVAL OF EXCESS SOLDER FROM A CIRCUIT  
SUBSTRATE

Date of deposit: March 20, 2006

I hereby certify that this paper is being facsimile transmitted or deposited with the United States Postal Service on the date indicated above, as first-class mail, with sufficient postage attached thereto, in an envelope addressed to Mail Stop For Amendments, Assistant Commissioner for Patents, Alexandria, VA 22313 or facsimile transmitted to 571-273-8300.

  
Signature of Person Mailing Paper

Indira Saladi  
Printed Name of Person Mailing Paper

REPLY UNDER 37 CFR 1.116

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action marked final and dated January 18, 2006, please enter the following remarks in the above-identified application as follows:

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.